

SSC8L82GT4

N-Channel Enhancement Mode MOSFET

> Features

| V _{DS} | V _{GS} | R _{DS(ON)} Typ. | ID |
|-----------------|-----------------|--------------------------|------|
| 80V | $\pm 20 V$ | 3.8mΩ@10V | 171A |

> Description

This device is N-Channel enhancement MOSFET. Uses SGT technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit.

100% UIS + ΔVDS + Rg Tested!

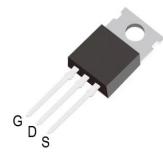
> Applications

- Load Switch
- PWM Application
- Power Management
- DC-DC Conversion

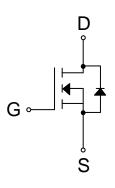
> Ordering Information

| Device | Package | Shipping |
|------------|-----------|----------|
| SSC8L82GT4 | TO-220-3L | 50/Tube |

Pin configuration







Pin Configuration



<u>Marking</u>

(XXYY: Internal Traceability Code)





| Symbol | Parameter | | Ratings | Unit |
|------------------|---|---------------------|---------|------|
| V _{DSS} | Drain-to-Source Voltage | | 80 | V |
| V _{GSS} | Gate-to-Source Volta | ge | ±20 | V |
| 1- | Continuous Drain Current ^d | Tc=25℃ | 171 | |
| ID | Continuous Drain Current [®] | Tc=100℃ | 95 | A |
| | Continuous Duois Current à | T _A =25℃ | 20 | |
| IDSM | Continuous Drain Current ^a | T _A =70℃ | 15 | A |
| Ідм | Pulsed Drain Current ^b | | 684 | А |
| D | Device Disain atting 6 | Tc=25℃ | 179 | 14/ |
| PD | Power Dissipation ° | Tc=100℃ | 71 | W |
| Pdsm | Device Disain ation 2 | T _A =25℃ | 2.5 | 10/ |
| | Power Dissipation ^a | T _A =70℃ | 1.6 | W |
| las | Avalanche Current ^b L=0.5mH Single Pulse | | 40 | А |
| Eas | Avalanche Energy ^b L=0.5mH Single Pulse | | 400 | mJ |
| TJ | Operation junction temperature | | -55~150 | °C |
| Тѕтс | Storage temperature range | | -55~150 | °C |

> Absolute Maximum Ratings ($T_A=25^{\circ}$ unless otherwise noted)

> Thermal Resistance Ratings ($T_A=25^{\circ}C$ unless otherwise noted)

| Symbol | Parameter | Туре | Max. | Unit |
|------------------|---|------|------|------|
| R _{0JA} | Junction-to-Ambient Thermal Resistance ^a | 50 | 65 | °C/W |
| R _{θJC} | Junction-to-Case Thermal Resistance | 0.7 | 1.0 | C/W |

Note:

- a. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with T_A=25 °C.The value in any given application depends on the user is specific board design. The power dissipation is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.

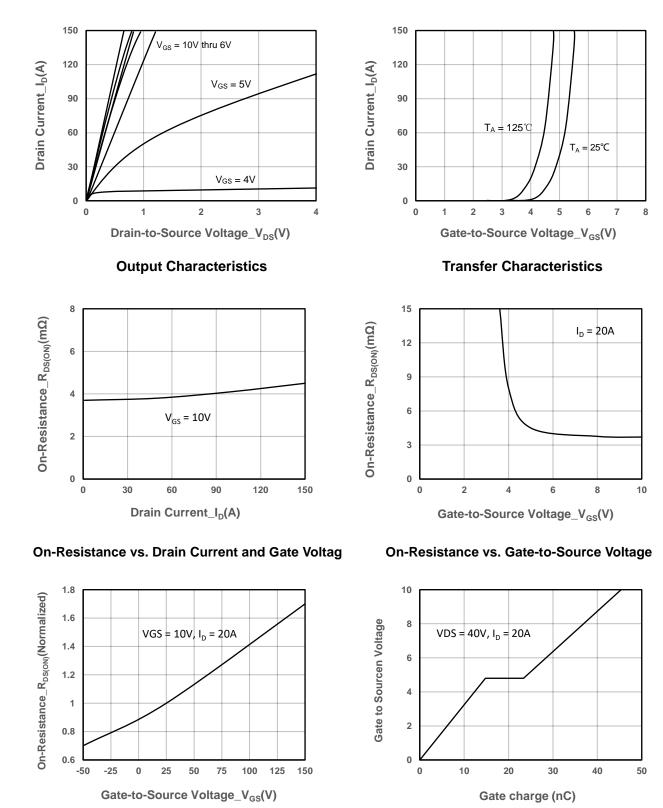


> Electrical Characteristics (T_A=25 $^{\circ}$ C unless otherwise noted)

| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
|---------------------------------|---------------------|--|------|------|------|------|
| Drain-Source Breakdown Voltage | V(BR)DSS | V _{GS} = 0V, I _D = 250µA | 80 | | | V |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}$, $I_D = 250 uA$ | 2 | 3 | 4 | V |
| Drain-Source On-Resistance | R _{DS(on)} | $V_{GS} = 10V, I_D = 20A$ | | 3.8 | 4.9 | mΩ |
| Zero Gate Voltage Drain Current | IDSS | $V_{DS} = 80V, V_{GS} = 0V$ | | | 1 | μA |
| Gate-Source Leak Current | lgss | $V_{GS} = \pm 20V, V_{DS} = 0V$ | | | ±100 | nA |
| Transconductance | G _{FS} | V _{DS} = 5V, I _D = 20A | | 30 | | s |
| Forward Voltage | V _{SD} | $V_{GS} = 0V, I_{S} = 20A$ | | 0.7 | 1.4 | V |
| Gate Resistance | Rg | V _{DS} = 0V, f = 1MHz | | 2.6 | | Ω |
| Input Capacitance | Ciss | | | 3240 | | |
| Output Capacitance | Coss | $V_{DS} = 40V, V_{GS} = 0V,$ f = 1MHz | | 1060 | | pF |
| Reverse Transfer Capacitance | C _{RSS} | | | 30 | | |
| Total Gate Charge | Q _G | V 40V/V 40V/ | | 48 | | |
| Gate to Source Charge | Q _{GS} | $V_{GS} = 10V, V_{DS} = 40V,$ | | 16 | | nC |
| Gate to Drain Charge | Q _{GD} | I _D = 20A | | 12 | | |
| Turn-on Delay Time | T _{D(ON)} | | | 18 | | |
| Rise Time | Tr | V_{GS} = 10V, V_{DS} = 40V, R_{L} | | 27 | | |
| Turn-off Delay Time | T _{D(OFF)} | $= 2\Omega, R_G = 3\Omega,$ | | 30 | | ns |
| Fall Time | T _f | | | 9 | | |
| Diode Recovery Time | Trr | I _F =20A, di/dt=100A/us | | 50 | | ns |
| Diode Recovery Charge | Qrr | I _F =20A, di/dt=100A/us | | 80 | | nC |



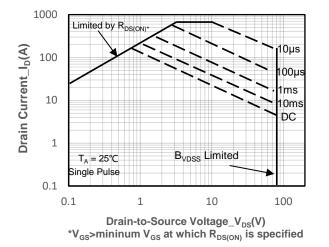
> Typical Performance Characteristics (T_A=25 $^{\circ}$ C unless otherwise noted)



Gate-Source Voltage vs. Gate charge

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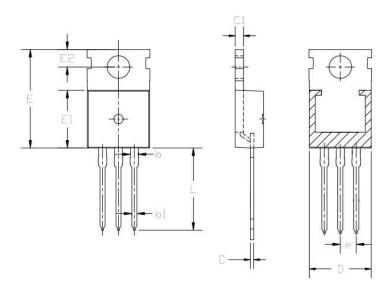
Safe Operating Area vs. Junction-to-Ambient



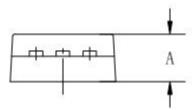


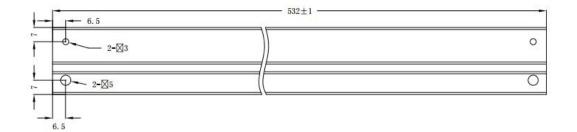
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Package Information

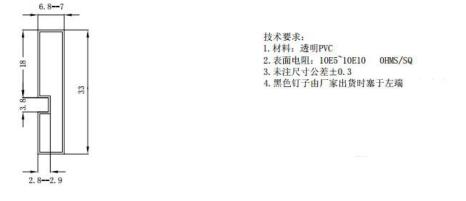


| onamou | MILLIMETER | | | |
|--------|------------|--------|-------|--|
| SYMBOL | MIN | NOM | MAX | |
| A | 4.40 | | 4.60 | |
| b | 1.20 | 153372 | 1.36 | |
| b1 | 0.70 | | 0.90 | |
| C | 0.48 | | 0.53 | |
| C1 | 1.28 | 1993 | 1.32 | |
| D | 9.80 | 10.00 | 10.20 | |
| E | 15.20 | 15,45 | 15,75 | |
| E1 | 9.00 | 9.20 | 9.40 | |
| E2 | 2.60 | 10,77 | 2.90 | |
| e | | 2.54 | | |
| L | 13.00 | 1222 | 13,40 | |





 $T=0.5 \pm 0.1$





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